

## **STW43N60DM2**

# N-channel 600 V, 0.085 Ω typ., 34 A MDmesh™ DM2 Power MOSFET in a TO-247 package

Datasheet - production data

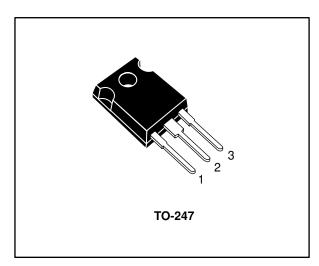
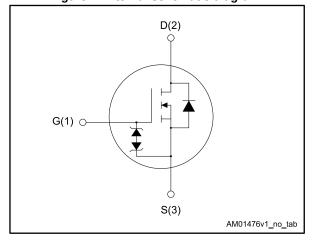


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub> @ T <sub>Jmax.</sub>	may I <sub>D</sub> F		Ртот
STW43N60DM2	650 V	0.093 Ω	34 A	250 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

### **Applications**

Switching applications

## **Description**

This high voltage N-channel Power MOSFET is part of the MDmesh  $^{TM}$  DM2 fast recovery diode series. It offers very low recovery charge ( $Q_{rr}$ ) and time ( $t_{rr}$ ) combined with low  $R_{DS(on)}$ , rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STW43N60DM2	43N60DM2	TO-247	Tube

Contents STW43N60DM2

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STW43N60DM2 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	±25	V
I-	Drain current (continuous) at T <sub>case</sub> = 25 °C	34	۸
I <sub>D</sub>	Drain current (continuous) at T <sub>case</sub> = 100 °C	21	A
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	136	Α
P <sub>TOT</sub>	Total dissipation at T <sub>case</sub> = 25 °C	250	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	50	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	V/IIS
T <sub>stg</sub>	Storage temperature		°C
T <sub>j</sub>	55 to		-0

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.50	000
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	50	°C/W

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive	6	Α
E <sub>AS</sub> <sup>(1)</sup>	Single pulse avalanche energy	800	mJ

#### Notes:

 $<sup>^{\</sup>left(1\right)}$  Pulse width is limited by safe operating area.

 $<sup>^{(2)}</sup>$   $I_{SD} \leq 34$  A, di/dt=900 A/µs;  $V_{DS}$  peak <  $V_{(BR)DSS},$   $V_{DD}$  = 400 V.

 $<sup>^{(3)}</sup>$  V<sub>DS</sub>  $\leq 480$  V.

 $<sup>^{(1)}</sup>$  starting  $T_j = 25~^{\circ}C,~I_D = I_{AR},~V_{DD} = 50~V.$ 

## 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			٧
	Zaro goto voltago drain	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$			1	
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{case} = 125 \text{ °C}$			100	
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±5	μΑ
$V_{GS(th)}$	Gate threshold voltage	$V_{DS}=V_{GS},I_D=250\;\mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17 A		0.085	0.093	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	2500	-	
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	-	120	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0 V$	-	3	-	Pi
C <sub>oss</sub>	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	200	-	рF
$R_{G}$	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4	-	Ω
$Q_g$	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 34 \text{ A},$	-	56	-	
$Q_{gs}$	Gate-source charge	V <sub>GS</sub> = 10 V (see <i>Figure 15</i> :		13	-	nC
$Q_{gd}$	Gate-drain charge	"Gate charge test circuit")	-	30	-	

#### Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 25 \text{ A}$	1	29	-	
t <sub>r</sub>	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 14: "Switching	1	27	-	
$t_{d(off)}$	Turn-off delay time	times test circuit for	-	85	-	ns
t <sub>f</sub>	Fall time	resistive load" and Figure 19: "Switching time waveform")	-	6	-	

 $<sup>^{(1)}</sup>$   $C_{oss\ eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

Table 8: Source-drain diode

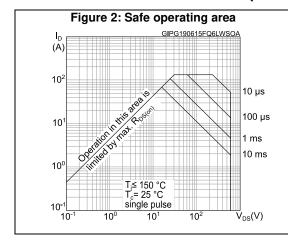
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		34	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		136	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 34 \text{ A}$	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 34 A,	-	120		ns
$Q_{rr}$	Reverse recovery charge	di/dt = 100 A/ $\mu$ s, $V_{DD}$ = 60 V (see <i>Figure 16</i> :	-	0.6		μC
I <sub>RRM</sub>	Reverse recovery current	"Test circuit for inductive load switching and diode recovery times")	-	10.4		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 34 A,	-	240		ns
Qrr	Reverse recovery charge	di/dt = 100 A/μs, V <sub>DD</sub> = 60 V, T <sub>i</sub> = 150 °C	-	2.4		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	20.5		А

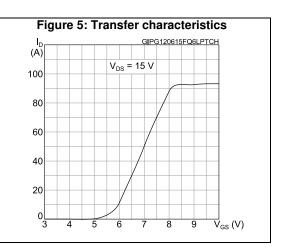
#### Notes:

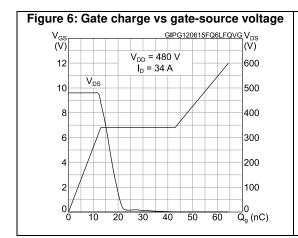
 $<sup>^{\</sup>left( 1\right) }$  Pulse width is limited by safe operating area.

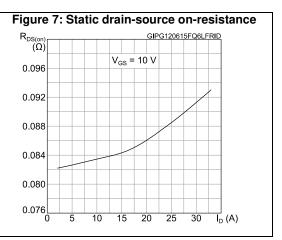
 $<sup>^{(2)}</sup>$  Pulse test: pulse duration = 300  $\mu s,$  duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)









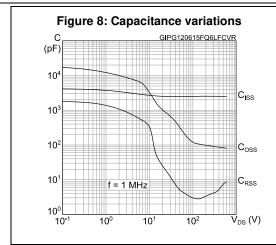


Figure 10: Normalized on-resistance vs temperature

R<sub>DS(on)</sub> GIPG120615FQ6LPRON
(norm.)

2.2

V<sub>GS</sub> = 10 V

1.8

1.4

1.0

0.6

0.2

-75

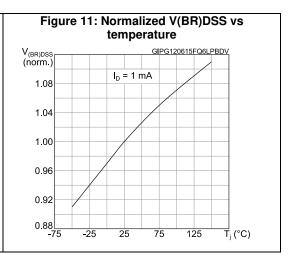
-25

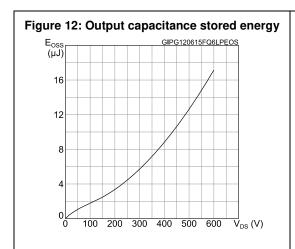
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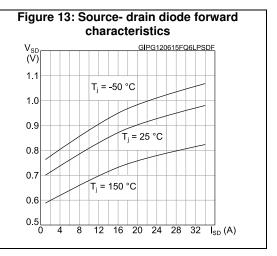
75

125

T<sub>j</sub> (°C)

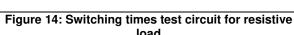


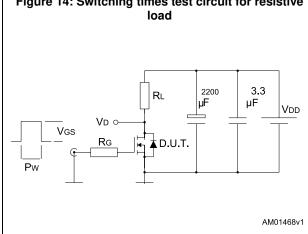




Test circuits STW43N60DM2

## 3 Test circuits





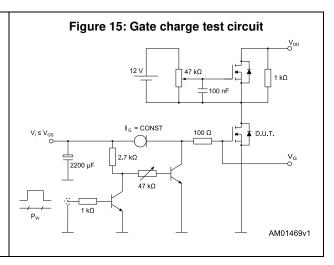


Figure 17: Unclamped inductive load test circuit

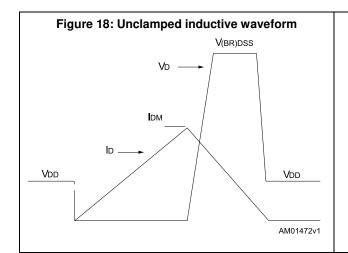
VD

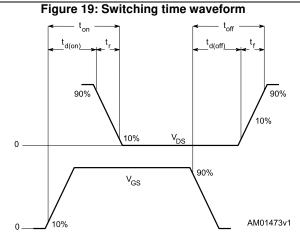
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## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

## 4.1 TO-247 package information

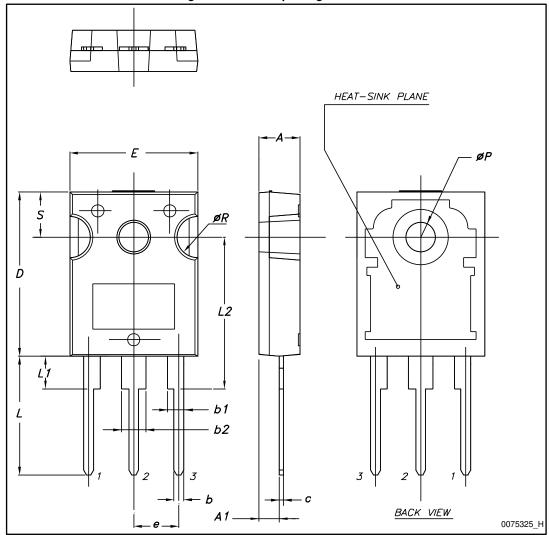


Figure 20: TO-247 package outline

Table 9: TO-247 package mechanical data

Di	·	mm.	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

STW43N60DM2 Revision history

# 5 Revision history

Table 10: Document revision history

Date	Revision	Changes
19-Jun-2015	1	Initial release. Part number STW43N60DM2 previously included in DocID026790
		On cover page: - updated title
02-Jul-2015	015 2	In section Electrical characteristics: - updated tables Static, Dynamic, Switching times and Source-drain diode
		In section Electrical characteristics (curves): - updated figures Gate charge vs gate-source voltage, Static drain-source on-resistance, and Capacitance variations

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